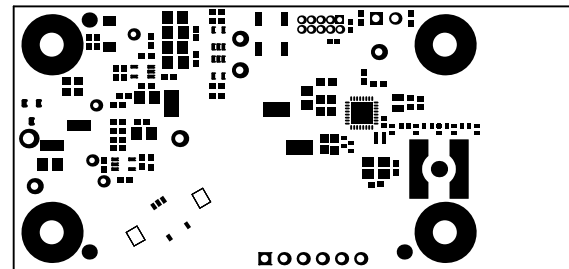
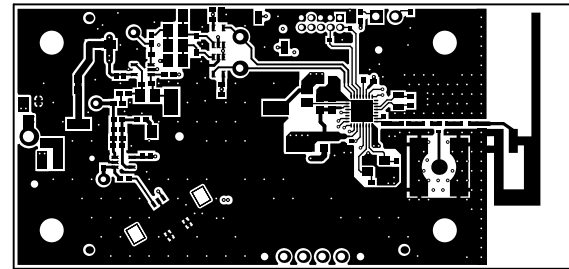


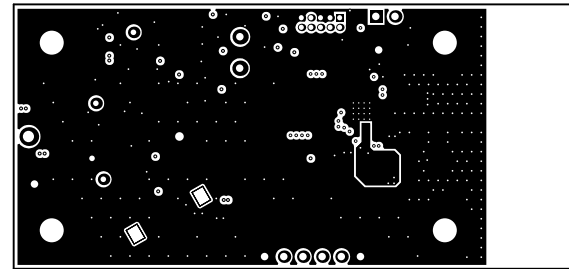
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00759		
PLOT NAME = Top Overlay	GENERATED : 2/22/2016	10:25:38 AM	TEXAS INSTRUMENTS



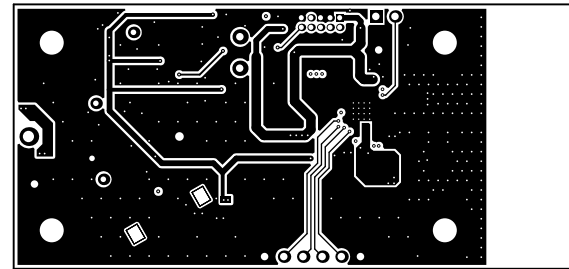
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00759		
PLOT NAME = Top Solder Mask	GENERATED : 2/22/2016 10:25:39 AM	TEXAS INSTRUMENTS	



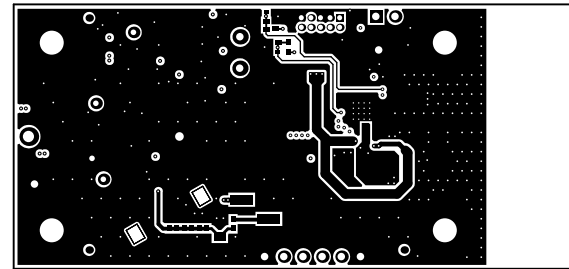
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer	TID #: TIDA-00759		
PLOT NAME = Top Layer	GENERATED : 2/22/2016 10:25:40 AM	TEXAS INSTRUMENTS	



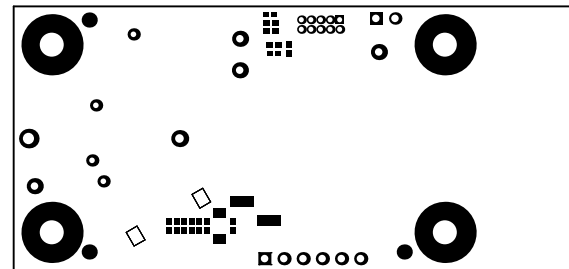
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 2 - GND	TID #: TIDA-00759		
PLOT NAME = Signal Layer 1	GENERATED : 2/22/2016 10:25:41 AM	TEXAS INSTRUMENTS	



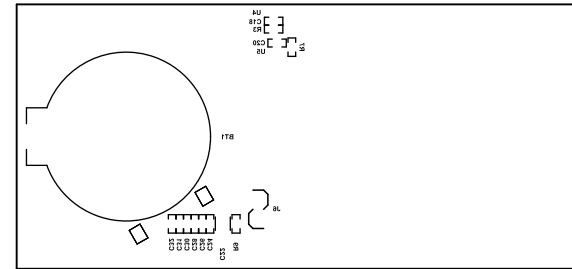
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - PWR	TID #: TIDA-00759		
PLOT NAME = Signal Layer 2	GENERATED : 2/22/2016 10:25:42 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - Bottom Layer	TID #: TIDA-00759		
PLOT NAME = Bottom Layer	GENERATED : 2/22/2016 10:25:44 AM	TEXAS INSTRUMENTS	

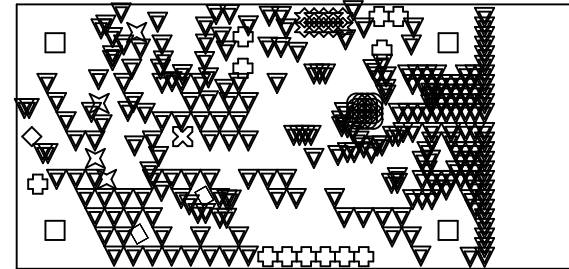


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00759		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/22/2016 10:25:45 AM	TEXAS INSTRUMENTS	



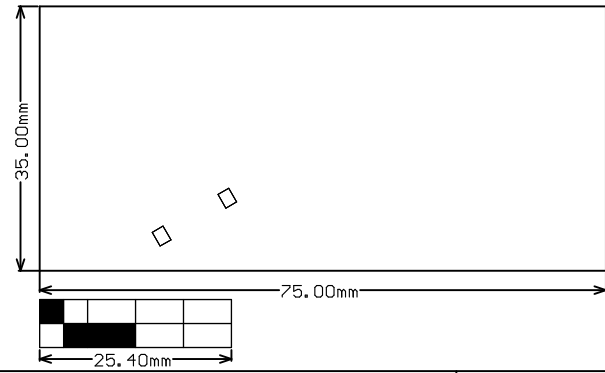
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00759		
PLOT NAME = Bottom Overlay	GENERATED : 2/22/2016 10:25:46 AM	TEXAS INSTRUMENTS	





Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	16	7.87mil (0.200mm)	PTH	Round
▼	250	10.00mil (0.254mm)	PTH	Round
☆	10	27.56mil (0.700mm)	PTH	Round
⊠	4	30.00mil (0.762mm)	PTH	Round
⊗	12	40.00mil (1.016mm)	PTH	Round
⊞	1	46.50mil (1.181mm)	PTH	Round
◇	1	59.06mil (1.500mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	298 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00759		
PLOT NAME = Drill Drawing	GENERATED : 2/22/2016	10:25:48 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4047	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00759		
PLOT NAME = Board Dimensions	GENERATED : 2/22/2016 10:25:49 AM	TEXAS INSTRUMENTS	

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